



# BCP69 series

20 V, 2 A PNP medium power transistors

Rev. 9 — 21 November 2024

Product data sheet

## 1. General description

PNP medium power transistors in a SOT223 (SC-73) Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- High current
- Three current gain selections
- High power dissipation capability
- AEC-Q101 qualified

## 3. Applications

- Linear voltage regulators
- High-side switches
- Battery-driven devices
- Power management
- MOSFET drivers
- Amplifiers

## 4. Quick reference data

Table 1. Quick reference data

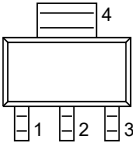
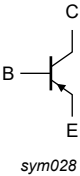
$T_{amb} = 25\text{ °C}$  unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{CEO}$	collector-emitter voltage	open base		-	-	-20	V
$I_C$	collector current			-	-	-2	A
$I_{CM}$	peak collector current	single pulse; $t_p \leq 1\text{ ms}$		-	-	-3	A
$h_{FE}$	DC current gain						
	BCP69	$V_{CE} = -1\text{ V}$ ; $I_C = -500\text{ mA}$ $T_{amb} = 25\text{ °C}$	[1]	85	-	375	
	BCP69-16		[1]	100	-	250	
	BCP69-25		[1]	160	-	375	

[1] pulsed;  $t_p \leq 300\text{ }\mu\text{s}$ ;  $\delta \leq 0.02$

5. Pinning information

Table 2. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	B	base		 sym028
2	C	collector		
3	E	emitter		
4	C	collector		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
<a href="#">BCP69</a>	-	plastic, surface-mounted package with increased heatsink; 4 leads; 2.3 mm pitch; 6.5 mm x 3.5 mm x 1.65 mm body	<a href="#">SOT223</a>
<a href="#">BCP69-16</a>			
<a href="#">BCP69-25</a>			

7. Marking

Table 4. Marking

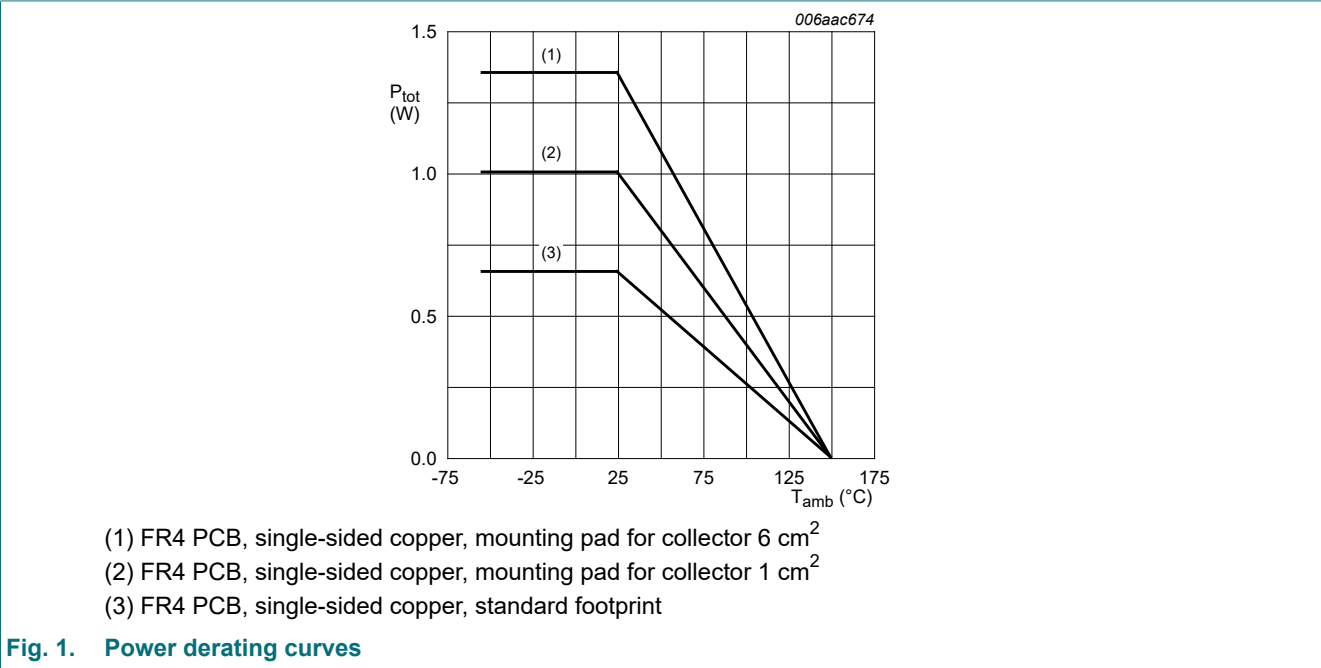
Type number	Marking code
BCP69	BCP69
BCP69-16	BCP69/16
BCP69-25	BCP69/25

8. Limiting values

Table 5. Limiting values  
In accordance with the Absolute Maximum Rating System (IEC 60134).  
 $T_{amb} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CBO}$	collector-base voltage	open emitter	-	-32	V
$V_{CEO}$	collector-emitter voltage	open base	-	-20	V
$V_{EBO}$	emitter-base voltage	open collector	-	-5	V
$I_C$	collector current		-	-2	A
$I_{CM}$	peak collector current	single pulse; $t_p \leq 1\text{ ms}$	-	-3	A
$I_B$	base current		-	-0.4	A
$I_{BM}$	peak base current	single pulse; $t_p \leq 1\text{ ms}$	-	-0.4	A
$P_{tot}$	total power dissipation	$T_{amb} \leq 25\text{ }^{\circ}\text{C}$ [1]	-	0.65	W
		[2]	-	1.00	W
		[3]	-	1.35	W
$T_j$	junction temperature		-	150	$^{\circ}\text{C}$
$T_{amb}$	ambient temperature		-55	150	$^{\circ}\text{C}$
$T_{stg}$	storage temperature		-65	150	$^{\circ}\text{C}$

- [1] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated and standard footprint.  
[2] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector  $1\text{ cm}^2$ .  
[3] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector  $6\text{ cm}^2$ .



9. Thermal characteristics

Table 6. Thermal characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	192	K/W
			[2]	-	-	125	K/W
			[3]	-	-	93	K/W
$R_{(j-sp)}$	thermal resistance from junction to solder point			-	-	16	K/W

- [1] Device mounted on an FR4 PCB; single-sided copper; tin-plated and standard footprint.  
[2] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.  
[3] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 6 cm<sup>2</sup>.

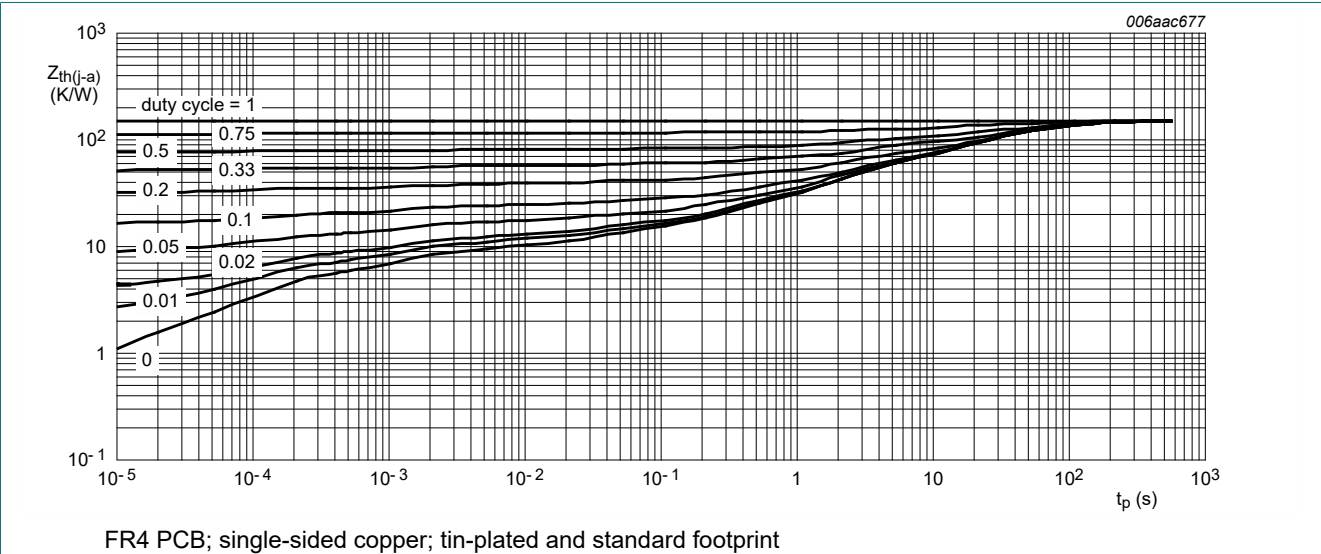


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

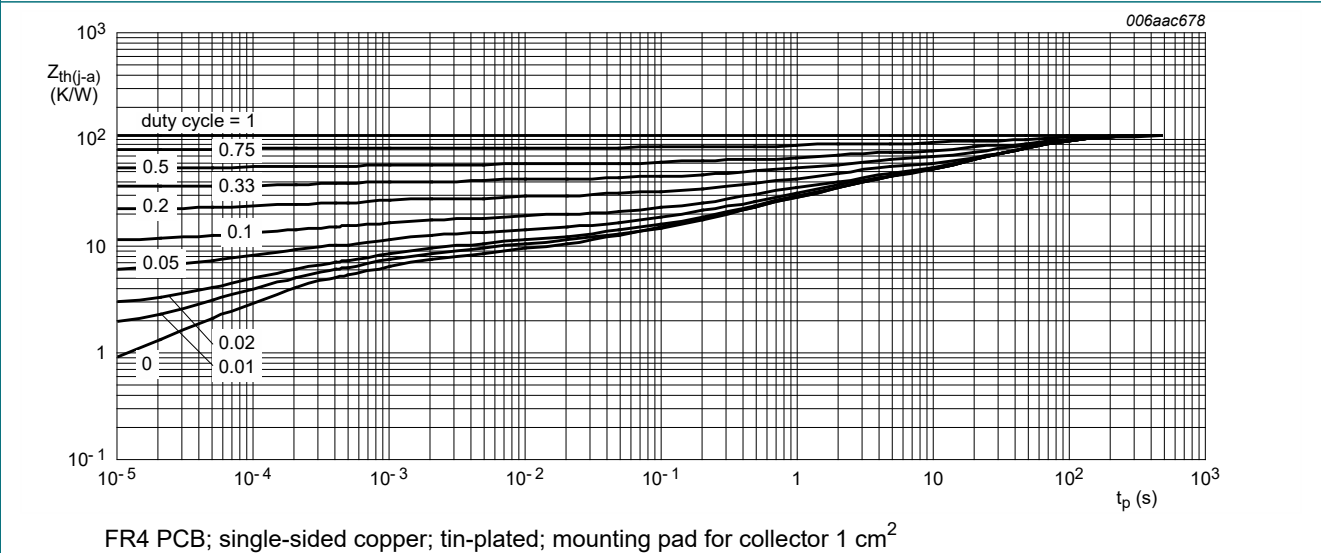
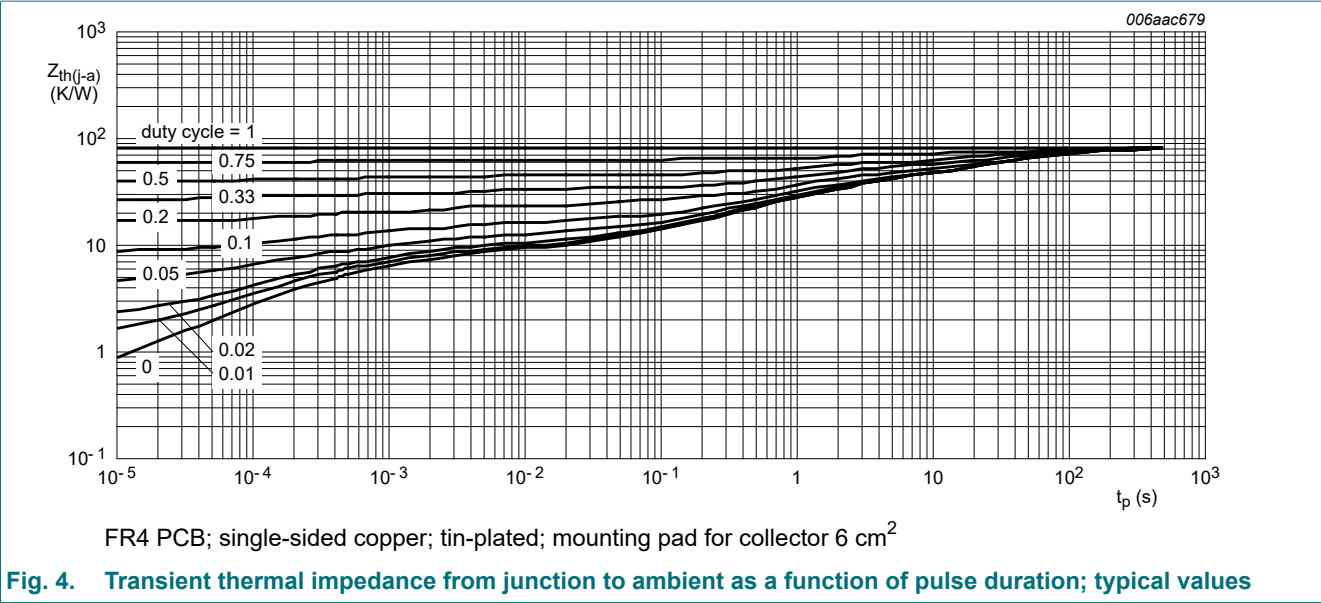


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
I <sub>CBO</sub>	collector-base cut-off current	V <sub>CB</sub> = -25 V; I <sub>E</sub> = 0 A T <sub>amb</sub> = 25 °C		-	-	-100	nA
		V <sub>CB</sub> = -25 V; I <sub>E</sub> = 0 A; T <sub>j</sub> = 150 °C		-	-	-10	µA
I <sub>EBO</sub>	emitter-base cut-off current	V <sub>EB</sub> = -5 V; I <sub>C</sub> = 0 A T <sub>amb</sub> = 25 °C		-	-	-100	nA
h <sub>FE</sub>	DC current gain						
	BCP69	V <sub>CE</sub> = -10 V; I <sub>C</sub> = -5 mA T <sub>amb</sub> = 25 °C	[1]	50	-	-	
		V <sub>CE</sub> = -1 V; I <sub>C</sub> = -500 mA T <sub>amb</sub> = 25 °C	[1]	85	-	375	
		V <sub>CE</sub> = -1 V; I <sub>C</sub> = -1 A T <sub>amb</sub> = 25 °C	[1]	60	-	-	
		V <sub>CE</sub> = -1 V; I <sub>C</sub> = -2 A T <sub>amb</sub> = 25 °C	[1]	40	-	-	
	BCP69-16	V <sub>CE</sub> = -10 V; I <sub>C</sub> = -5 mA T <sub>amb</sub> = 25 °C	[1]	50	-	-	
		V <sub>CE</sub> = -1 V; I <sub>C</sub> = -500 mA T <sub>amb</sub> = 25 °C	[1]	100	-	250	
		V <sub>CE</sub> = -1 V; I <sub>C</sub> = -1 A T <sub>amb</sub> = 25 °C	[1]	60	-	-	
		V <sub>CE</sub> = -1 V; I <sub>C</sub> = -2 A T <sub>amb</sub> = 25 °C	[1]	40	-	-	
	BCP69-25	V <sub>CE</sub> = -10 V; I <sub>C</sub> = -5 mA T <sub>amb</sub> = 25 °C	[1]	50	-	-	
		V <sub>CE</sub> = -1 V; I <sub>C</sub> = -500 mA T <sub>amb</sub> = 25 °C	[1]	160	-	375	
		V <sub>CE</sub> = -1 V; I <sub>C</sub> = -1 A T <sub>amb</sub> = 25 °C	[1]	60	-	-	
		V <sub>CE</sub> = -1 V; I <sub>C</sub> = -2 A T <sub>amb</sub> = 25 °C	[1]	40	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	I <sub>C</sub> = -1 A; I <sub>B</sub> = -100 mA T <sub>amb</sub> = 25 °C	[1]	-	-	-0.5	V
		I <sub>C</sub> = -2 A; I <sub>B</sub> = -200 mA T <sub>amb</sub> = 25 °C	[1]	-	-	-0.6	V
V <sub>BE</sub>	base-emitter voltage	V <sub>CE</sub> = -10 V; I <sub>C</sub> = -5 mA T <sub>amb</sub> = 25 °C	[1]	-	-	-0.7	V
		V <sub>CE</sub> = -1 V; I <sub>C</sub> = -1 A T <sub>amb</sub> = 25 °C	[1]	-	-	-1	V
C <sub>c</sub>	collector capacitance	V <sub>CB</sub> = -10 V; I <sub>E</sub> = i <sub>e</sub> = 0 A; f = 1 MHz T <sub>amb</sub> = 25 °C		-	28	-	pF
f <sub>T</sub>	transition frequency	V <sub>CE</sub> = -5 V; I <sub>C</sub> = -50 mA; f = 100 MHz T <sub>amb</sub> = 25 °C		40	140	-	MHz

[1] pulsed; t<sub>p</sub> ≤ 300 µs; δ ≤ 0.02

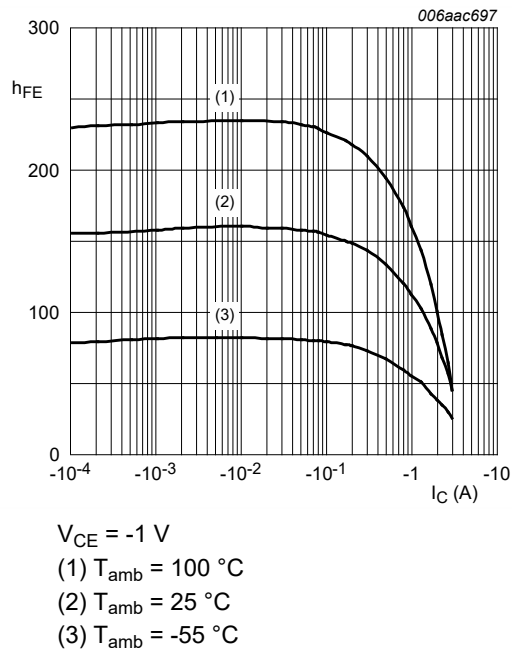


Fig. 5. hFE selection -16: DC current gain as a function of collector current; typical values

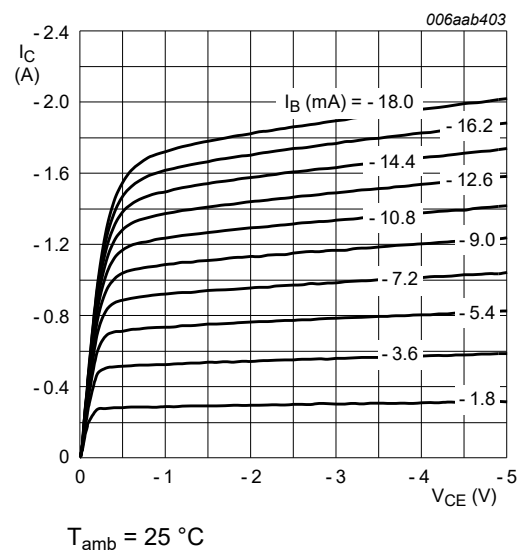


Fig. 6. hFE selection -16: Collector current as a function of collector-emitter voltage; typical values

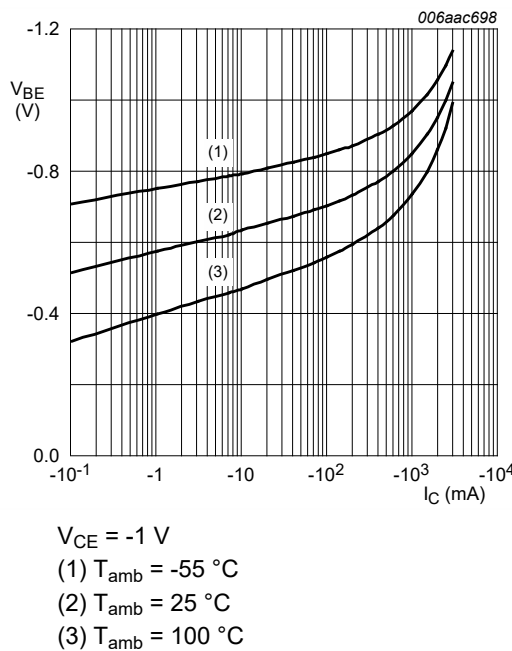


Fig. 7. hFE selection -16: Base-emitter voltage as a function of collector current; typical values

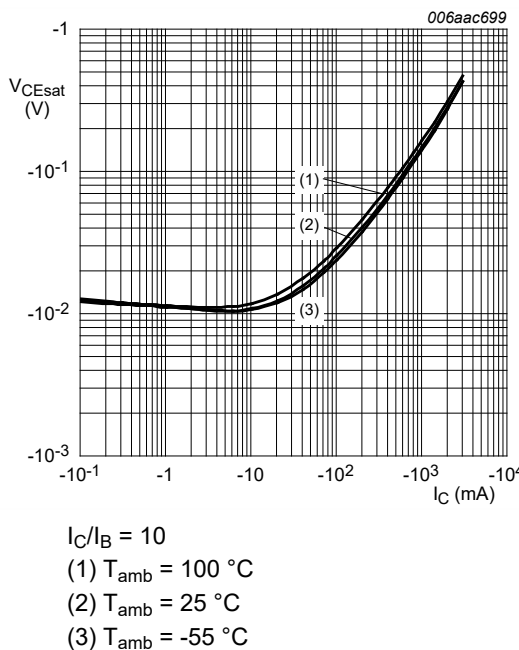


Fig. 8. hFE selection -16: Collector-emitter saturation voltage as a function of collector current; typical values

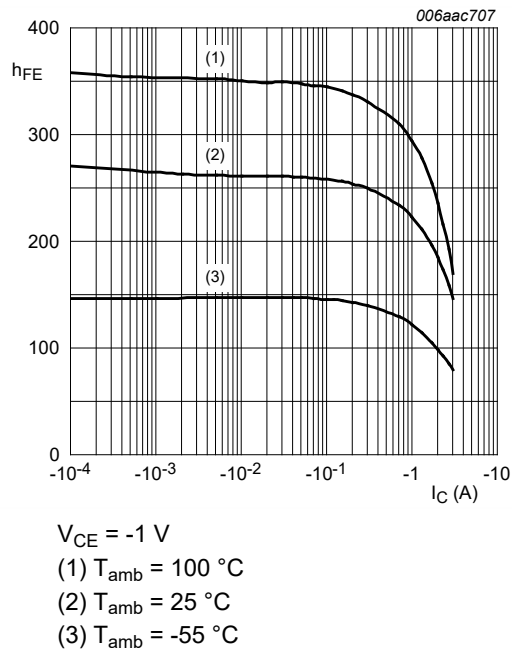


Fig. 9. hFE selection -25: DC current gain as a function of collector current; typical values

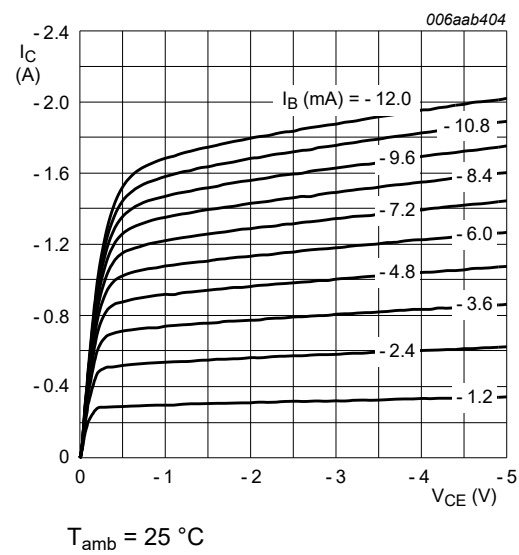


Fig. 10. hFE selection -25: Collector current as a function of collector-emitter voltage; typical values

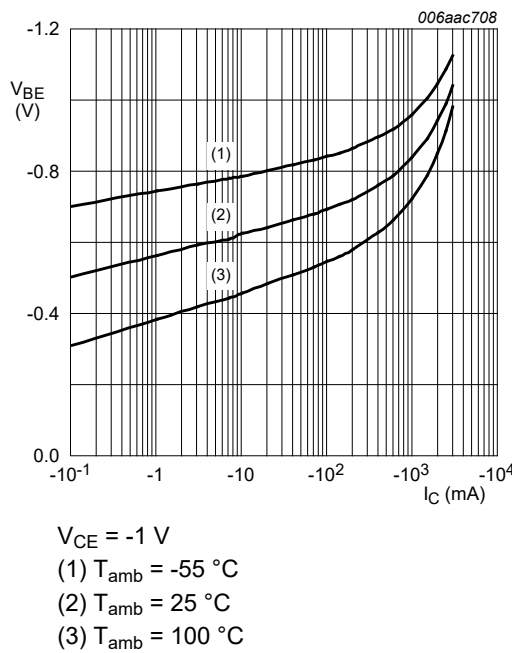


Fig. 11. hFE selection -25: Base-emitter voltage as a function of collector current; typical values

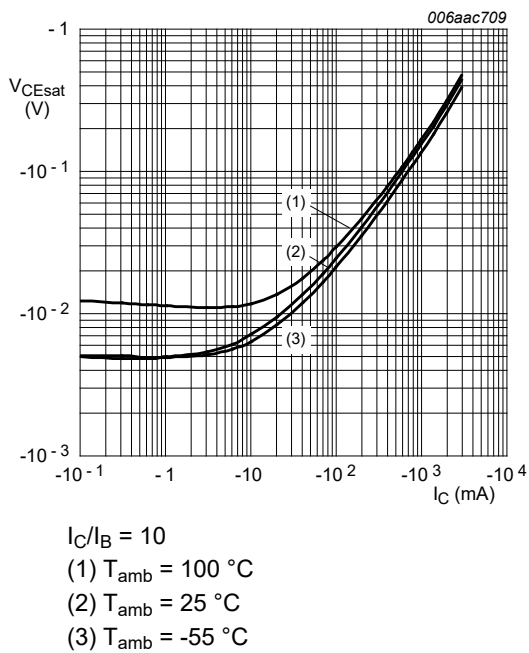


Fig. 12. hFE selection -25: Collector-emitter saturation voltage as a function of collector current; typical values

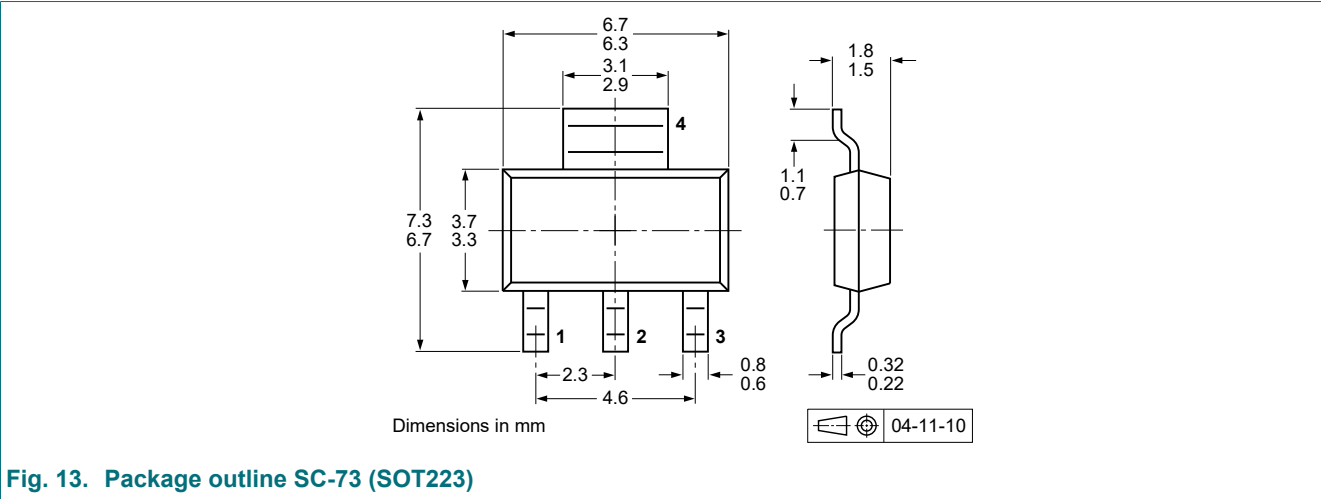


11. Test information

11.1. Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline



13. Soldering

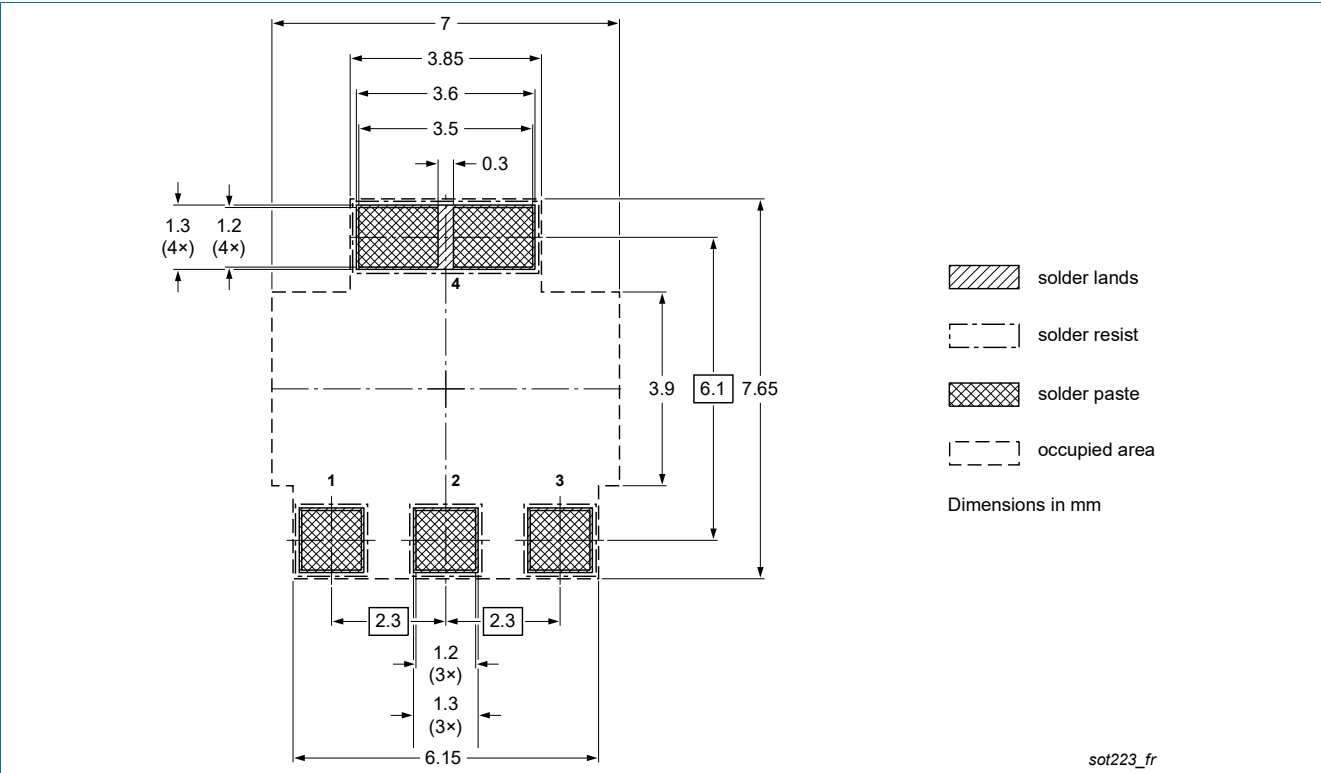


Fig. 14. Reflow soldering footprint for SC-73 (SOT223)

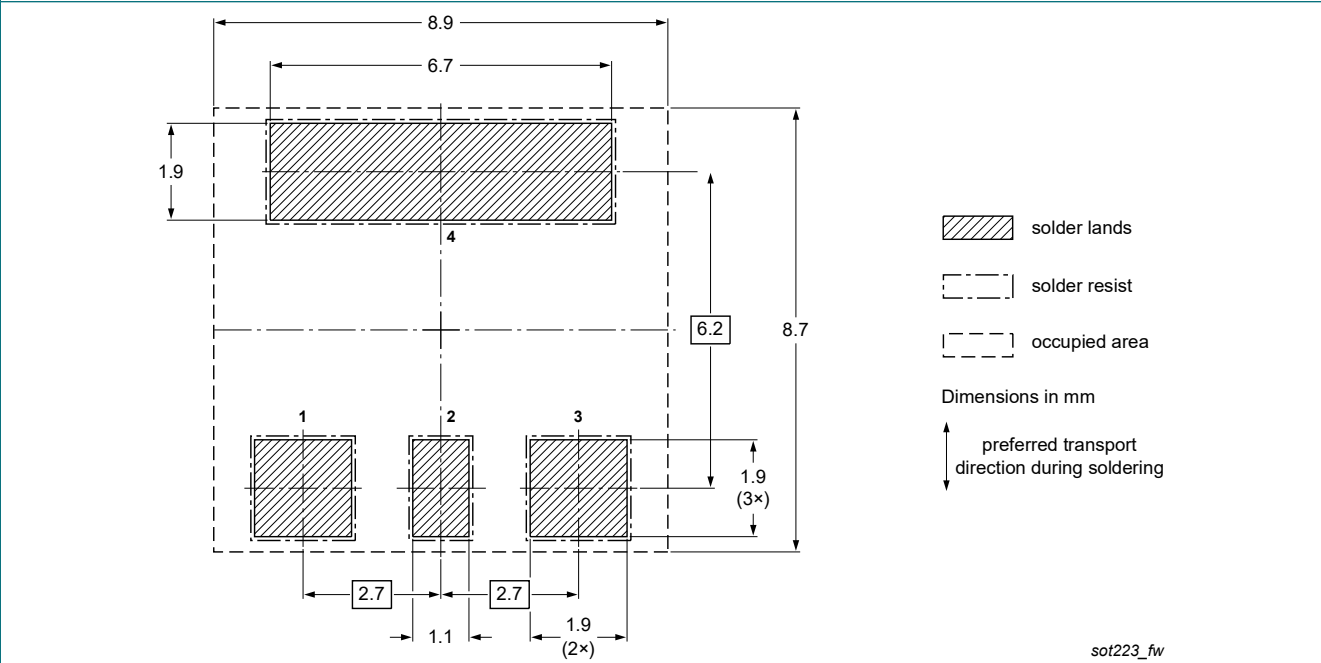


Fig. 15. Wave soldering footprint for SC-73 (SOT223)

14. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BCP69_SER v.9	20241121	Product data sheet	-	BCP69_BC869_BC69PA v.8
Modifications:	• Quick reference data: conditions at $h_{FE}$ corrected			
BCP69_SER v.8	20240704	Product data sheet	-	BCP69_BC869_BC69PA v.7
BCP69_BC869_BC69PA v.7	20111012	Product data sheet	-	BC869_6 BCP69_6
BC869_6	20041108	Product data sheet	-	BC869_5
BC869_5	20031202	Product specification	-	BC869_4
BC869_4	19990408	Product specification	-	BC869_3
BC869_3	19980716	Product specification	-	BC869_CNV_2
BC869_CNV_2	19970401	Product specification	-	-
BCP69_6	20081202	Product data sheet	-	BCP69_5
BCP69_5	20031125	Product specification	-	BCP69_4
BCP69_4	20021115	Product specification	-	BCP69_3
BCP69_3	19990408	Product specification	-	BCP69_CNV_2
BCP69_CNV_2	19970312	Product specification	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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